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Product Change Notification - JAON-15JIKR494 (Printer Friendly)

Date: 02 Mar 2016

Product Category: Analog (Linear & Mixed Signal) AND Interface; Analog

(Thermal, Power Management & Safety)

Notification CCB 2542 Initial Notice: Qualification of palladium coated subject: copper with gold flash (CuPdAu) bond wire for products

fabricated at XFGM available in 8L PDIP package at MMT

assembly site.

Notification text: PCN Status:

Initial notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for products fabricated at XFGM available in 8L PDIP package at MMT assembly site.

Pre Change:

Gold (Au) bond wire

Post Change:

Palladium coated copper with gold flash (CuPdAu) bond wire

Pre and Post Change Summary:

	Pre Change	Post Change MMT assembly site					
Assembly Site	MMT assembly site						
Wire material	Au wire	CuPdAu wire					
Die attach material	CRM-1064L	CRM-1064L					

Molding compound material	GE800	GE800
Lead frame material	CDA194	CDA194

Impacts to Data Sheet:

None

Reason for Change:

To improve productivity and qualifying Palladium coated copper with gold flash (CuPdAu) bond wire.

Change Implementation Status:

In Progress

Estimated First Ship Date:

June 30, 2016 (date code: 1626)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Summary Table:

	March 2016			April 2016			May 2016				June 2016							
WW	09	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	2
Initial PCN Issue Date	Х																	
Qual Report Availability															Х			
Final PCN Issue Date															Х			
Implementation Date																	Х	

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

March 2, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): PCN_JAON-15JIKR494_Qual_Plan.pdf

PCN_JAON-15JIKR494_Affected_CPN.pdf PCN_JAON-15JIKR494_Affected_CPN.xls

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